



# On the temperature dependence of the current conduction mode in non-homogeneous Pt/*n*-GaN Schottky barrier diode

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## ABSTRACT

Forward current-voltage (*I*-*V*) measurements of Pt/*n*-GaN Schottky barrier diode (SBD) are investigated in a wide temperature range (80–400 K). The temperature dependence of the effective Schottky barrier height (SBH) and ideality factor are analyzed on the basis of the thermionic emission (*TE*) model by considering a double Gaussian distribution (DGD) of SBH due to the presence of barrier height inhomogeneities at the Pt/*n*-GaN interface. In the high temperature (HT) region (200–400 K), Pt/*n*-GaN SBD exhibits nearly an ideal behavior in accordance with the *TE* conduction mode. The obtained values of the homogeneous SBH  $\Phi_{0bn} = 1.33$  eV and Richardson constant  $A_{HT}^* = 26.86$  A cm<sup>-2</sup> K<sup>-2</sup> are in agreement with the theoretical values for *n*-type GaN. In the low temperature (LT) region (80–160 K), the corresponding values  $\Phi_{0bn} = 0.94$  eV and  $A_{LT}^* = 14.74$  A cm<sup>-2</sup> K<sup>-2</sup> deduced within the *TE* mode deviate strongly from the ideal behavior. This deviation is further confirmed by the large ideality factor. In this work, we provide a strong evidence that the tunneling current including thermionic field emission (*TFE*) largely dominates the conduction mode at low temperature.

## 1. Introduction

GaN and its related alloys have attracted much interest over the past decade due to their potential application in the field of semiconductor devices [1,2]. For instance, GaN semiconductor has promising physical features for the development of GaN-based high power, high speed and high frequency electronic devices such as the field effect transistors (MESFETs) [1,2], and high electron mobility transistors (HEMTs) [3–5]. The most popular examples of GaN-based applications include blue and ultraviolet (UV) light-emitting diodes (LEDs) [6]. In particular, GaN-based Schottky barrier diodes (SBD) have been used as a component for the above electronic and optoelectronic devices. In this respect, high quality ohmic and Schottky contacts are required. Therefore, a deep understanding of the electrical characteristics of metal (M)/GaN contacts is of fundamental and technological importance for developing GaN based-electronic and optoelectronic devices [7–13]. To this end, several challenges should be addressed in order to have M/GaN devices characterized with high Schottky barrier height (SBH), an ideality factor (*n*) close to unity and a low reverse current. Effectively, the low Schottky

barrier height induces excess current through M/GaN SBD in both forward and reverse characteristics that strongly affects the SBD performances. The thermionic emission (*TE*) model is usually used to extract the Schottky parameters (barrier height and ideality factor), using current-voltage (*I*-*V*) measurements. The extracted values often exhibit an abnormal temperature dependence. This is reflected by the increase of the barrier height and the decrease of the ideality factor with increasing temperature. This abnormal behavior has been analyzed on the basis of the *TE* model by taking into account the presence of the barrier height inhomogeneities (*BHi*) located at the metal/semiconductor (M/Sc) interface [14–27]. Actually, several models have been developed to describe the *BHi* at M/Sc interface [28–30]. The model developed by Werner and Güttler [28] considers a Gaussian distribution (GD) of SBH with a standard deviation ( $\sigma_s$ ) around mean barrier height ( $\Phi_{bn}$ ) value. In the latter model, the effective SBH is shown to be both temperature and bias dependent.

Besides the above abnormal features observed in previous reports [16–20], a double Gaussian distribution (DGD) of a non-homogeneous M/Sc Schottky contacts has also been reported. Such DGD is

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associated with low (LT) and high (HT) temperature regimes, respectively. Among other important electrical parameters, Richardson constant ( $A^*$ ) is found to be strongly affected by the presence of  $BH_i$ . This is especially true for the Richardson constant at low temperature regime ( $A_{LT}^*$ ). For instance, Huan et al [16] and Yildirim et al [18] have assumed the existence of DGD of the barrier heights in Pt/ $n$ -4H-SiC and Ni/ $n$ -Ga $N$ , respectively. In the low temperature region, the extracted Richardson constant ( $A_{LT}^* = 37.4 \text{ A.cm}^{-2}\text{K}^{-2}$ ) for Pt/ $n$ -4H-SiC is found to be much lower than the theoretical value ( $146 \text{ A.cm}^{-2}\text{K}^{-2}$ ) [31,32], by contrast to the corresponding high temperature region extracted value  $A_{HT}^* = 148.5 \text{ A.cm}^{-2}\text{K}^{-2}$  [16]. Ni/ $n$ -Ga $N$  system exhibits also a DGD of SBH in the temperature regions of 80–180 K and 200–400 K [18] with respective values of  $A^* = 80$  and  $85 \text{ A.cm}^{-2}\text{K}^{-2}$ . On the other hand, Kumar et al [19] have reported deduced  $A^*$  values for Ni/ $n$ -Ga $N$  of  $48 \text{ A.cm}^{-2}\text{K}^{-2}$  in 100–200 K range, and  $29.2 \text{ A.cm}^{-2}\text{K}^{-2}$  in 200–380 K range. Reddy et al [33] investigated the electrical properties of Ru/Pt/ $n$ -Ga $N$  in the temperature region of 100–420 K. By assuming a DGD, they reported,  $A_{LT}^* = 10.29 \text{ A.cm}^{-2}\text{K}^{-2}$  and  $A_{HT}^* = 27.83 \text{ A.cm}^{-2}\text{K}^{-2}$ . Furthermore, Iucolano et al [34] and Zhou et al [35] have performed measurements on Pt/ $n$ -Ga $N$  system at high temperature regime only (300–450K) and (298–473 K), respectively. They obtained a single GD associated with high temperature  $A_{HT}^*$  value of 25 and  $35 \text{ A.cm}^{-2}\text{K}^{-2}$ , respectively. The above mentioned results indicate clearly a strong discrepancy in the deduced values of  $A^*$ . It is worth to mention that Pt-Ga $N$  system shows a very good rectifying characteristics with  $A^*$  at HT close to the theoretical value ( $26.9 \text{ A.cm}^{-2}\text{K}^{-2}$ ) [36]. This makes it an ideal candidate for exploring further this discrepancy in the reported results. A systematic investigation of the temperature dependence of the electrical characteristics of Pt/ $n$ -Ga $N$  SBD over a wide temperature range should enable exploring the conduction modes, especially associated with the observed abnormal feature in the low temperature regime.

In this work, the temperature dependent forward current-voltage ( $I$ - $V$ ) characteristics were used to analyze the  $BH_i$  at Pt/ $n$ -Ga $N$  SBD. The observed anomalies in the current-voltage characteristics were analyzed using the potential fluctuation model with two Gaussian distributions of barrier heights. In particular, the values of  $A_{LT}^*$  and  $A_{HT}^*$  deduced from the DGD of the barrier height are discussed in terms of current conduction modes at Pt/ $n$ -Ga $N$  SBD. We show that  $TE$  model describes properly the current transport mechanism in the HT regime, while the thermionic field emission ( $TFE$ ) governs the current transport at LT regime in Pt/ $n$ -Ga $N$  SBD.

## 2. Experimental details

$n$ -type Ga $N$  epitaxial layers with a free carrier density of  $(2\text{--}3) \times 10^{17} \text{ cm}^{-3}$  and a thickness of about 1200 nm, was grown on (0001)  $\text{Al}_2\text{O}_3$ -plane substrate using the metal organic chemical vapor deposition (MOCVD) technique. A low resistance ohmic contact was formed prior SBD fabrication by electron beam deposition of Ti/Al/Ni/Au on the front side of the Ga $N$  epilayer, and subsequent annealing at  $500^\circ\text{C}$  for 5 min in a high purity Ar atmosphere was performed [16]. Prior to Schottky contact deposition, the samples were degreased and dipped in an HCl: H $_2$ O (1:1) solution. Circular Pt Schottky contacts 0.66 mm in diameter and 120 nm in thickness were fabricated on the  $n$ -Ga $N$  epitaxial layers through a metal contact mask by electron beam deposition. A schematic three-dimensional structure of the fabricated Pt/ $n$ -Ga $N$  device is displayed in Fig. 1(a), and the energy band diagram of Pt/ $n$ -Ga $N$  contacts is shown in Fig. 1 (b).

Temperature-dependent  $I$ - $V$  measurements on Pt/ $n$ -Ga $N$  SBDs were carried out in the range 80–400 K. The details of the SBD fabrication and  $I$ - $V$  measurement have been reported elsewhere [20].

## 3. Results and discussion

### 3.1. Investigation of electrical parameters based on the thermionic emission conduction model

Fig. 2 displays the semi-logarithmic plot of the forward current-voltage measurements of Pt/ $n$ -Ga $N$  SBD as a function of temperature ranging between 80 and 400 K. It shows that the forward  $\ln(I)$ - $V$  curve exhibits a linear behavior over a large applied forward voltage range for the considered temperature region. Moreover, the current increases with increasing temperature as predicted by the thermionic emission model regardless of the applied voltage considered.

In the framework of thermionic emission, the current through a SBD can be expressed as [37]:

$$I = I_s \left[ \exp \left( \frac{q(V - R_s I)}{nk_B T} \right) - 1 \right] \quad (1a)$$

where  $n$  is the ideality factor,  $R_s$  the series resistance,  $V_F$  the applied forward voltage and  $I_s$  the saturation current given by:

$$I_s = A^* S T^2 \exp \left( - \frac{\Phi_{0bn}}{k_B T} \right) \quad (1b)$$

where  $\Phi_{0bn}$  is the effective barrier height at zero bias,  $A^*$  the modified

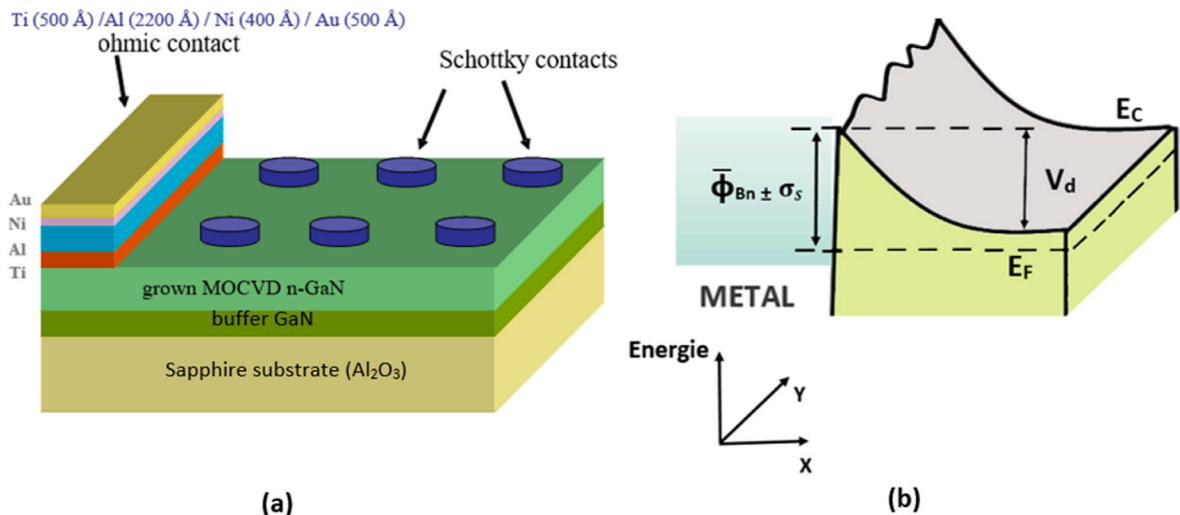
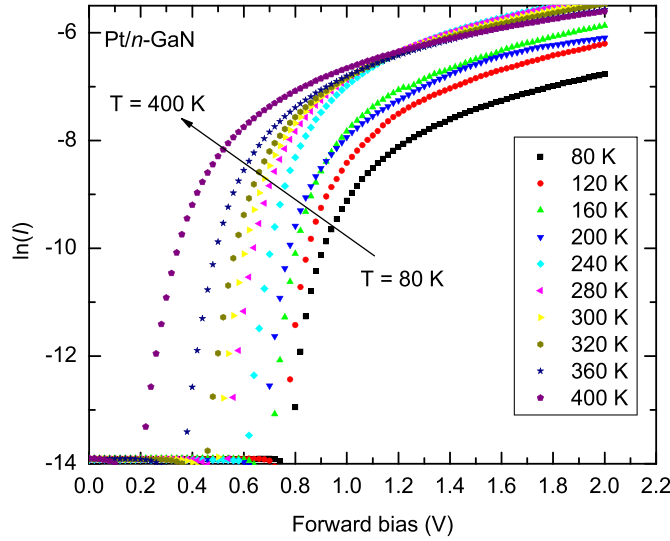


Fig. 1. (a) A Schematic cross section view of Pt/ $n$ -Ga $N$  SBD. (b) A schematic energy band diagram of Pt/ $n$ -Ga $N$  SBD (not to scale).



**Fig. 2.** Experimental forward  $I$ - $V$  curves of Pt/n-GaN SBD measured at different temperatures.

Richardson constant with a corresponding theoretical value of  $26.9 \text{ A cm}^{-2} \text{ K}^{-2}$  for M/n-type GaN Schottky contacts [36],  $S$  the area of the diode,  $T$  the temperature and  $k_B$  the Boltzmann constant. The series resistance  $R_s$  was determined using the Werner method [38], while the ideality factor,  $n$  as defined in equation (1) was deduced from the slope of the semi logarithmic  $I$ - $V$  characteristics.

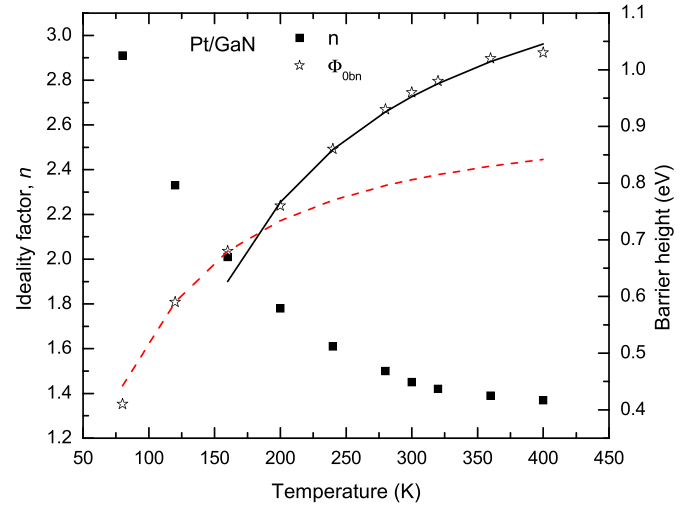
$$n = \frac{q}{k_B T} \frac{dV}{d(\ln I)} \quad (2)$$

The respective experimental values of  $\Phi_{0bn}$  and  $n$  were obtained from the fitting of the semi logarithmic  $I$ - $V$  curve using equations (1) and (2). Their temperature dependence is displayed in Table I (and plotted in Fig. 3). The two Schottky parameters,  $\Phi_{0bn}$  and  $n$  exhibit strong temperature dependence, namely  $\Phi_{0bn}$  increases and  $n$  decreases with increasing temperature. As mentioned above, Werner method [38] was used to determine the series resistance of the structure and its temperature dependence is also presented in Table I. The series resistance increases with increasing temperature as is expected for semiconductors in the temperature region where there is no freezing out of carriers. The abnormal temperature dependence of  $\Phi_{0bn}$  and  $n$  is usually interpreted in terms of barrier height inhomogeneities located at the M/Sc interface [16–20,39–43]. As explained in inhomogeneous SBD model [29], the current conduction is dominated by current flowing through patches exhibiting lower barrier height and a large ideality factor at lower temperatures. When the temperature increases, the electrons gain enough thermal energy to overcome the higher barrier. Hence, the temperature dependence of both the barrier height and the ideality

**Table 1**

Electrical parameters determined from forward  $I$ - $V$  characteristics at different temperatures.

Temperature (K)	Current density (A/cm <sup>2</sup> )	Ideality factor $n$	$\Phi_{0bn}$ (eV)	$R_s$ ( $\Omega$ )
80	$2.6 \times 10^{-21}$	2.91	0.41	920
120	$6.6 \times 10^{-20}$	2.33	0.59	630
160	$2.7 \times 10^{-16}$	2.01	0.68	425
200	$7.7 \times 10^{-14}$	1.78	0.76	473
240	$1.4 \times 10^{-12}$	1.61	0.86	314
280	$3.9 \times 10^{-11}$	1.5	0.93	306
300	$1.8 \times 10^{-10}$	1.45	0.96	314
320	$10^{-9}$	1.42	0.98	306
360	$1.9 \times 10^{-8}$	1.39	1.02	345
400	$4.6 \times 10^{-7}$	1.37	1.03	406



**Fig. 3.** Deduced effective barrier heights  $\Phi_{0bn}$  and ideality factor  $n$  as a function of temperature for Pt/n-GaN SBD. Broken and solid lines are for the calculated SBHs using equation (3) for two Gaussian distributions of SBHs in LT region (80–160 K) and HT region (200–400 K), respectively.

factor are consistent with SBH inhomogeneity. According to the inhomogeneous model [29], a linear correlation between  $\Phi_{0bn}$  and  $n$  is expected. Such a correlation is associated with the non-homogenous Schottky contacts. Actually, the experimental values of  $\Phi_{0bn}$  versus  $n$  reported in Fig. 4(a) could be fitted using rather two straight lines with a transition occurring at 160 K. It is worth noting that from the extrapolation of  $\Phi_{0bn}$  versus  $n$  plot to the ideal case ( $n = 1$ ), the deduced values at LT (80–160 K) and HT (200–400 K) regions of the zero-bias mean value  $\bar{\Phi}_{0bn}$  are 0.99 eV and 1.26 eV, respectively. The ideality factor is also analyzed by plotting  $nk_B T$  versus  $k_B T$ . Such variation is displayed in Fig. 4(b) and shows a linear relationship in the high temperature region (140–300 K) and is parallel to the ideal case ( $n = 1$ ), indicating that the TE is the dominant current transport mechanism in our SBD at HT regime.

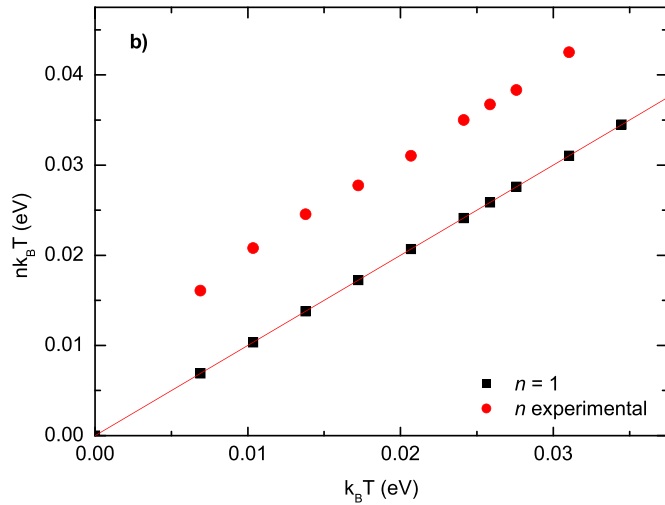
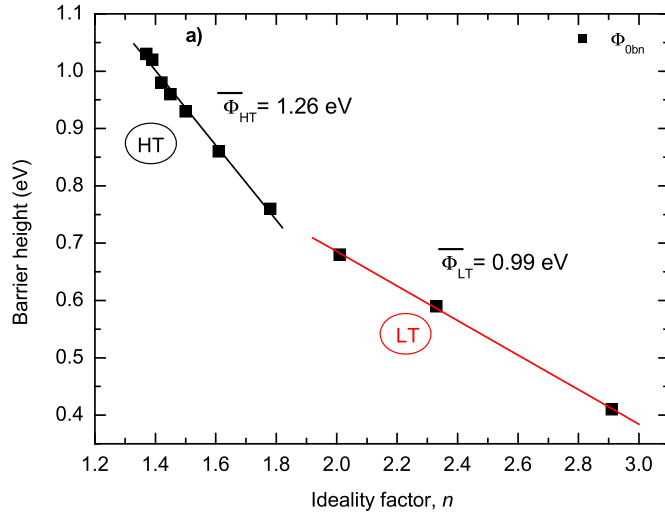
According to the BHI model, the spatial inhomogeneities of SBH at the interface are interpreted in terms of a Gaussian spatial distribution of SBHs around zero-bias of mean value  $\bar{\Phi}_{0bn}$  and with a zero-bias standard deviation  $\sigma_{0s}$  [17–20]. The effective barrier height ( $\Phi_{0bn}$ ) as a function of temperature can be evaluated using:

$$\Phi_{0bn} = \bar{\Phi}_{0bn} - \frac{q^2 \sigma_{0s}^2}{2k_B T} \quad (3)$$

The plot of  $\Phi_{0bn}$  versus  $1/2k_B T$  should then result in a straight line with a y-axis intercept equals to  $\bar{\Phi}_{0bn}$  and a slope giving the zero-bias standard deviation  $\sigma_{0s}$ . The corresponding plot displayed in Fig. 5 shows a linear behavior but with two different slopes and also two different y-intercepts, with a transition occurring at 160 K. This result may indicate the presence of two Gaussian distributions of SBHs over the Schottky contact area. Accordingly, the deduced values at LT (80–160 K) and HT (200–400 K) regions of the zero-bias mean value  $\bar{\Phi}_{0bn}$  and the associated zero-bias standard deviation  $\sigma_{0s}$  are ( $\bar{\Phi}_{0bn} = 1.32 \text{ eV}$   $\sigma_{0s} = 140 \text{ mV}$ ) and ( $\bar{\Phi}_{0bn} = 0.96 \text{ eV}$   $\sigma_{0s} = 86 \text{ mV}$ ), respectively.

In fact, the DGD assumption is supported by the fitting of  $\Phi_{0bn}(T)$  shown in Fig. 3 using the above values of  $\bar{\Phi}_{0bn}$  and  $\sigma_{0s}$ , where the two LT and HT temperature regions are clearly evidenced. Moreover, the respective LT and HT mean value of SBH  $\bar{\Phi}_{0bn} = 0.96 \text{ eV}$  and  $1.32 \text{ eV}$  deduced from Fig. 5 match exactly with the mean SBHs values obtained from  $\Phi_{0bn}$  versus  $n$  plot of Fig. 4(a).

The presence of SBH inhomogeneity was also used to explain the deviation from linearity at low temperature in the conventional Richardson plot, namely  $\ln(I_s/T^2)$  vs.  $1/k_B T$ . Considering the SBH



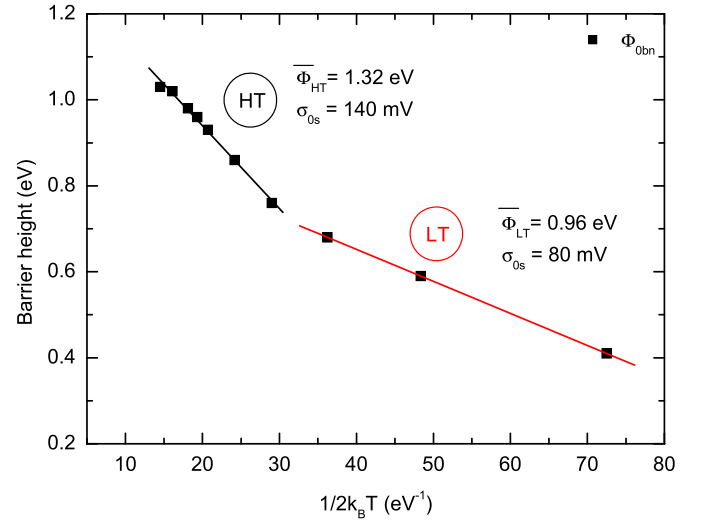
**Fig. 4.** (a) Effective barrier heights  $\Phi_{obn}$  vs. ideality factor  $n$  and, (b)  $nk_B T$  vs.  $k_B T$  plots of Pt/n-GaN SBD at different temperatures.

inhomogeneity with double Gaussian distribution of the barrier heights, the modified Richardson plot can be obtained by combining equations (1b) and (3):

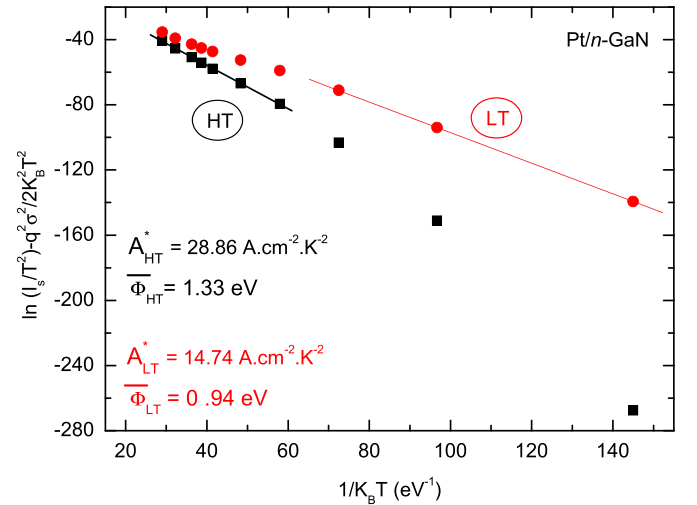
$$\ln \left( \frac{I_S}{T^2} \right) - \left( \frac{q^2 \sigma_{0s}^2}{2k_B^2 T^2} \right) = \ln(A^* S) - \frac{\bar{\Phi}_{obn}}{2k_B T} \quad (4)$$

The modified Richardson plots were determined using the two values of  $\sigma_{0s}$  corresponding to the HT and LT regions.

According to equation (4), the modified  $[\ln(I_S/T^2) - (q^2 \sigma_{0s}^2 / 2k_B^2 T^2)]$  vs.  $1/2k_B T$  plot should be a straight line with the intercept at the ordinate giving the modified Richardson constant  $A^*$ , and the slope giving the zero-bias mean value  $\bar{\Phi}_{obn}$  of SBH (see Fig. 6). The solid squares represent the values corresponding to HT region calculated using  $\sigma_{0s} = 140$  mV, and the solid circles represent the values related to LT region calculated using  $\sigma_{0s} = 86$  mV. The result obtained from the analysis of the plots in Fig. 6 provides two sets of deduced values of  $A^*$  and  $\bar{\Phi}_{obn}$  corresponding to LT and HT regions (see Table II). The deduced  $\bar{\Phi}_{obn}$  values of 0.94 and 1.33 eV in the two temperature regions match well with the values obtained from the  $\Phi_{obn}$  vs.  $1/2k_B T$  plots of Fig. 5 (see Table II). The extracted values of Richardson constant at HT region  $A_{HT}^*$



**Fig. 5.** The effective barrier heights  $\Phi_{obn}$  versus  $1/2k_B T$  curves of Pt/n-GaN SBD according to the barrier inhomogeneous model [28].



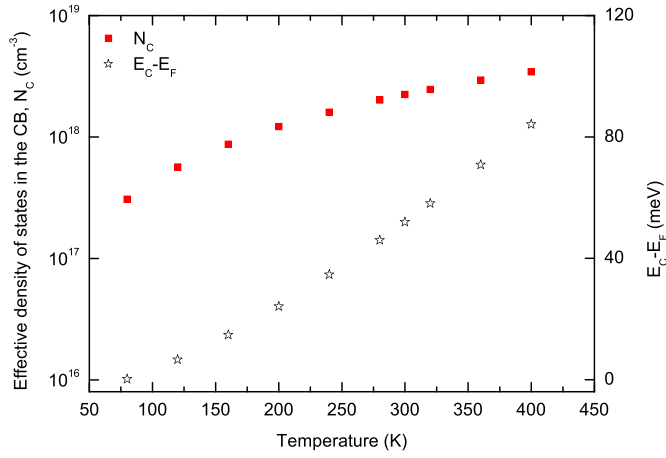
**Fig. 6.** Modified Richardson plots  $\ln \left( \frac{I_S}{T^2} \right) - \left( \frac{q^2 \sigma_{0s}^2}{2k_B^2 T^2} \right)$  vs.  $(1/k_B T)$  associated with both LT and HT regions.

**Table 2**

Summary of the extracted experimental homogenous SBH and Richardson's constant in the LT and HT regions, along with the results reported in the literature.

System	Theoretical A.cm<sup>-2</sup>.K<sup>-2</sup>	$A_{LT}^*$ A. cm<sup>-2</sup>.K<sup>-2</sup>	$A_{HT}^*$ A. cm<sup>-2</sup>.K<sup>-2</sup>	$\bar{\Phi}_{obn}$ (eV) (LT)	$\bar{\Phi}_{obn}$ (eV) (HT)	References
Pt/n-GaN	26.9	14.74	26.86	0.94	1.33	This work
Ru/Pt/n-GaN		10.29	27.83	0.47	0.99	[22]
Pt/n-GaN		NA	25	NA	1.21	[23]
Pt/n-GaN		NA	35	-	-	[24]
Ni/n-GaN		80	85	0.72	1.42	[14]
Ni/n-GaN		48	29.2	0.73	1.4	[15]

(NA) Not Applicable.  $I$ - $V$  measurements have been performed on M/Sc system at high temperature regime only.



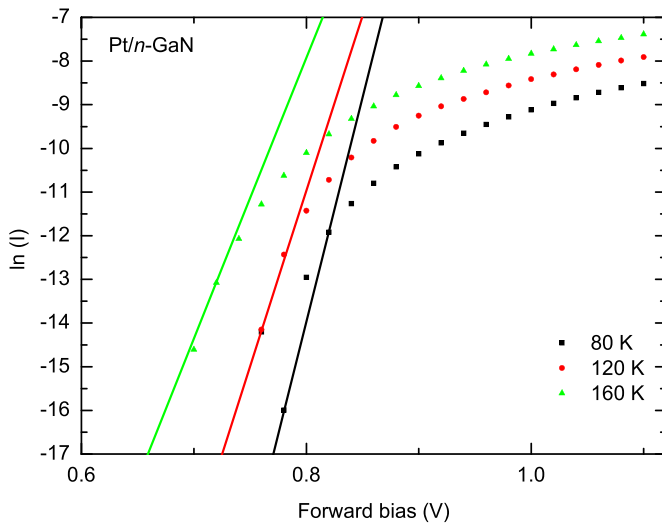
**Fig. 7.** Effective density of states  $N_C$  and the energy difference between the conduction band minimum and Fermi level ( $E_C - E_F$ ) of Pt/n-GaN SBD as a function of temperature.

$= 26.86 \text{ A cm}^{-2} \text{ K}^{-2}$  is in very good agreement with the theoretical value of  $26.9 \text{ A cm}^{-2} \text{ K}^{-2}$ . By contrast its LT counterpart value  $A_{LT}^* = 14.74 \text{ A cm}^{-2} \text{ K}^{-2}$  is much lower.

This discrepancy between the theoretical value of  $A^*$  and the experimental extracted value in the low temperature range may indicate that the *TE* is not the major driving conduction mode. We argue that other modes of conduction such as the tunneling current including thermionic field emission (*TFE*) may principally govern the current transport at low temperature regime.

### 3.2. Investigation of the conduction modes in Pt/n-GaN SBD upon temperature

The *BHi* model associated with Gaussian distribution of SBH shows two distinct temperature regions. Current transport mode in each region (LT and HT) must therefore be considered in the evaluation of inhomogeneities at Pt/n-GaN contacts. The high temperature region presents often a behavior in accordance with thermionic conduction mode. In the low temperature region, the *I-V* characteristics could be characterized by a relatively excess of a forward current. This can be attributed to the presence of other dominant current transport modes such as



**Fig. 8.** Experimental forward current curves at the temperatures of 80, 120, and 160 K, and the corresponding fitting curves to *I-V* characteristics according to the *TFE* model.

quantum tunneling including thermionic field emission (*TFE*). Indeed, the values of the ideality factor much larger than the unity, the low values of both the barrier height and the Richardson constant obtained in the low temperature range ( $\leq 160 \text{ K}$ ) are usually an indication that the *TE* might no longer be the major conduction mode. Considering the above abnormal features at low temperature regime, we suggest that the *TFE* is the dominant conduction mode as will be evidenced below. From now onwards, the focus will be on the results obtained in the low temperature range ( $\leq 160 \text{ K}$ ).

The *I-V* relation for a Schottky diode based on the *TFE* theory is given by Ref. [44]:

$$I = I_s \left[ \exp \left( \frac{q(V - R_s I)}{E_0} \right) - 1 \right] \quad (5a)$$

where

$$I_{s,TFE} = SA^* T \frac{\sqrt{\pi q E_{00} (\Phi_{bnt} - V) - (E_C - E_F)}}{k_B \cosh \left( \frac{E_{00}}{k_B T} \right)} \exp \left[ -\frac{E_C - E_F}{k_B T} \right] \exp \left[ \frac{(E_C - E_F) + q(V - \Phi_{bnt})}{E_0} \right] \quad (5b)$$

with

$$E_0 = E_{00} \coth \left[ \frac{E_{00}}{k_B T} \right] = n_{tun} k_B T$$

with

$$E_{00} = \hbar \left/ 2 \left[ \frac{N_D}{m^* \epsilon_s} \right]^{1/2} \right.$$

where  $N_D$  is the doping density,  $m^*$  the effective mass of electron, and  $\epsilon_s$  the dielectric constant of GaN.

The depth of Fermi level below the conduction band minimum  $E_C$  is expressed as:

$$E_C - E_F = k_B T \ln \left( \frac{N_C}{N_D} \right) \quad (6)$$

where  $N_C$  is the effective density of states in the conduction band expressed at given temperature  $T$  by:

$$N_C(T) = \frac{2}{h^3} (2\pi m^* k_B T)^{3/2} = 2.5 \times 10^{19} \text{ (cm}^{-3}\text{)} \left[ \frac{m^*}{m_0} \right]^{3/2} \left[ \frac{T}{T_0} \right]^{3/2} \quad (7)$$

and  $T_0$  is the room temperature,  $m_0$  the free electron mass; the other entries have their usual meaning.

The doping density  $N_D$  obtained from *C-V* measurement for this GaN sample of about  $3 \times 10^{17} \text{ cm}^{-3}$  is weakly temperature dependent, whereas  $N_C$  decreases substantially with decreasing temperature. The variation of both  $N_C$  and  $(E_C - E_F)$  as a function of temperature is shown in Fig. 7. The Fermi level lies in the vicinity of the conduction band at lower temperature, with a maximum value of 14.7 meV at 160 K. Therefore, this GaN can be considered as a degenerate semiconductor likewise heavily doped. This result supports further the assumption that the current transport mode across SBD is dominated by the quantum tunneling transport [45]. Indeed, the *I-V* curves at temperature below 160 K are well fitted using Eqs. (5a) and (5b) based on the *TFE* model as shown in Fig. 8. The extracted characteristics parameters from curves fitting using Eqs. (5a) and (5b), namely  $n_{tun}$ ,  $\Phi_{bnt}$ , and  $E_C - E_F$  based on *TFE* model are reported in Table III.

The above results provide a good evidence that the existence of the DGD, usually observed in M/Sc contacts can be well interpreted in terms of two different conduction modes: (i) a dominant thermionic emission mode at high temperature regime, and (ii) a dominant tunneling thermionic field emission at low temperature regime.



**Table 3**

Summary of the fitting parameters used for  $I$ - $V$  characteristics of Pt/ $n$ -GaN SBD in  $TFE$  mode.

Temperature (K)	$\Phi_{bnt}$ (eV)	$n_{tun}$	$E_C-E_F$ (meV)
80	1.01	1.38	0.18
120	1.04	1.17	6.56
160	1.06	1.01	14.70

#### 4. Conclusion

In this work, we have investigated the temperature dependence of the forward current-voltage characteristics of Pt/ $n$ -GaN Schottky contacts in order to explain the abnormal behavior usually observed associated with the double Gaussian distribution of the SBH within the  $TE$  model. Such abnormal SBH distribution is associated with two main regions usually low (80–160K) and high (200–400) temperature range. Numerous works show incoherent values of SBH, ideality factor and Richardson constant at low temperature region. We demonstrate in this work that the above abnormal features observed at low temperature are correlated with the use of the  $TE$  conduction mode. Indeed, the  $TFE$  model has been utilized to interpret properly the low temperature regime. The deviation from the  $TE$  current at low temperature is thus explained by the occurrence of degeneracy-like of GaN and the whole  $I$ - $V$  characteristics at low temperature region are well fitted within the  $TFE$  model.

It is therefore of paramount importance to consider tunneling conduction mode at low temperature regime when investigating the barrier height inhomogeneities in devices involving GaN-based Schottky contacts.

#### CRediT authorship contribution statement

**Mohammed Mamor:** Conceptualization, Data curation, Formal analysis, Investigation, Methodology, Writing – original draft, Writing – review & editing. **Khalid Bouziane:** Writing – original draft, Conceptualization, Data curation, Formal analysis, Investigation, Methodology, Writing – review & editing. **Hind Chakir:** Conceptualization, Data curation, Formal analysis, Investigation, Methodology, Writing – original draft, Writing – review & editing. **Pierre Ruterana:** Writing – review & editing, Writing – original draft, Conceptualization, Data curation, Formal analysis, Investigation, Methodology.

#### Declaration of competing interest

The authors declare that they have no known competing financial interests or personal relationships that could have appeared to influence the work reported in this paper.

#### Data availability

Data will be made available on request.

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